



P.E.S. College of Engineering, Mandya - 571 401

(An Autonomous Institution affiliated to VTU, Belgaum)

Sixth Semester, B.E. – Electronics and Communication Engineering

Semester End Examination; June - 2016

Microwave Devices and Integrated Circuits

Time: 3 hrs

Max. Marks: 100

Note: i) Answer **FIVE** full questions, selecting **ONE** full question from each Unit.
ii) Assume missing data suitably.

UNIT - I

1 a. Define the term reflection coefficient and transmission coefficient for a transmission line

and derive equation $T^2 = \frac{Z_L}{Z_o} (1 - \tau_i^2)$. 8

b. Define standing waves. Obtain the equation for maximum and minimum amplitude and phase of standing wave. Sketch the pattern of standing wave in lossy and lossless line. 8

c. A transmission line has the following parameters :

$R = 2 \Omega/m$, $G = 0.5 \text{ m mho/m}$, $f = 1 \text{ GHz}$, $L = 8 \text{ nH/m}$, $C = 0.23 \text{ pF}$. 4

Calculate : i) Characteristic impedance ii) Propagation constant.

2 a. Derive equation for line impedance at any point on the line from the receiving end in terms of Z_L and Z_0 . 6

b. What are the applications of smith chart? Explain briefly. 6

c. A lossless line of characteristic impedance $R_0 = 50 \Omega$ is to be matched to a load :

$Z_L = 50/[2 + j(2 + \sqrt{3})] \Omega$ by means of a lossless short-circuited stub. The characteristic impedance of the stub is 100Ω . Find the stub position and length so that a match is obtained. 8

UNIT - II

3 a. Derive the relevant equations for the propagation of TE waves in a rectangular waveguide and explain how the dominant mode is obtained. 12

b. Explain Faraday rotation isolator with a neat sketch. 8

4 a. Derive an expression for output power and output current of two-cavity klystron. 8

b. List the differences between travelling wave tube and klystron. 4

c. A reflex klystron-operates under the following conditions :

$V_0 = 600 \text{ V}$, $L = 1 \text{ mm}$, $R_{sh} = 15 \text{ k}\Omega$, $\frac{e}{m} = 1.759 \times 10^{11}$, $f_r = 9 \text{ GHz}$

The tube is oscillating at f , at the peak of the $n = 2$ mode or $1\frac{3}{4}$ mode. Assume that the transit time through the gap and beam loading can be neglected. 8

- i) Find the value of the repeller voltage.
- ii) Find the direct current to give a microwave gap voltage of 200 V.
- iii) What is the electronic efficiency under this condition?

UNIT - III

- 5 a. What are the different properties of scattering parameters? Explain briefly. 8
- b. With necessary conditions write the scattering matrix representation of multiport network. 7
- c. Explain the salient features of co-axial connectors and adaptors, with diagrams. 5
- 6 a. Explain with neat diagram the working principle of non-reciprocal phase shifter. 6
- b. Explain the characteristics of magic tee passive device, with a schematic diagram. Also obtain the S matrix representation of the magic-tee. 8
- c. With neat diagram of a microwave attenuator explain the operation of the same. 6

UNIT - IV

- 7 a. Explain the principles of operation of the Gunn diode with formation of Gunn domain. Also explain the modes of operation of the Gunn diode with Gunn-oscillation mode. 10
- b. Explain the construction and working of PIN diode and IMPATT diode. 10
- 8 a. Explain the operation of the Schottky-barrier diode with its structure. Also explain the fabrication technique with sputtering of aluminium on silicon wafers. Draw the characteristics of Schottky-barrier diode and write its symbol. 10
- b. Write a note on : 10
 - i) TRAPATT diode
 - ii) READ diode.

UNIT - V

- 9 a. Explain the construction, field pattern and losses in micro strip line. 8
- b. With neat diagram, explain the operation of parallel strip line and write the expressions for distributed parameters of parallel strip lines, characteristic impedance and attenuation of the same. 8
- c. Define the different losses taking place in micro strip line. 4
- 10 a. Briefly explain MIC fabrication techniques. 10
- b. Explain the accomplishment of circuit definition by means of,
 - (i) Plate through technique 10
 - (ii) Etch-back technique

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